# **MA6X718** (MA718)

# Silicon epitaxial planar type

For switching

For wave detection

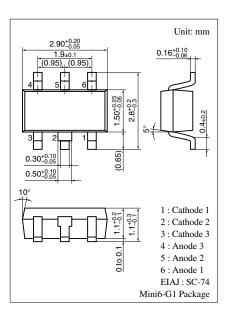
#### ■ Features

- Three isolated elements are contained in one package, allowing high-density mounting
- Two MA3X704A (MA704A) is contained in one package (of a type in the same direction)
- Low forward voltage V<sub>F</sub>, optimum for low voltage rectification
- Optimum for high frequency rectification because of its short reverse recovery time (t<sub>rr</sub>)
- Mini type 6-pin package

## ■ Absolute Maximum Ratings $T_a = 25$ °C

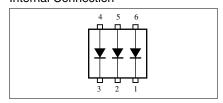
Parameter	Symbol	Rating	Unit
Reverse voltage (DC)	$V_R$	30	V
Peak forward current *	$I_{FM}$	150	mA
Forward current (DC) *	$I_F$	30	mA
Junction temperature	$T_{j}$	125	°C
Storage temperature	$T_{stg}$	-55 to +125	°C

Note) \*: Value per a diode



Marking Symbol: M2N

#### Internal Connection



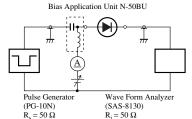
### ■ Electrical Characteristics $T_a = 25$ °C

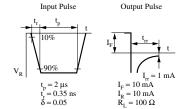
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current (DC)	$I_R$	$V_R = 30 \text{ V}$			1	μΑ
Forward voltage (DC)	V <sub>F1</sub>	I <sub>F</sub> = 1 mA			0.4	V
	V <sub>F2</sub>	$I_F = 30 \text{ mA}$			1.0	
Terminal capacitance	C <sub>t</sub>	$V_R = 1 \text{ V, } f = 1 \text{ MHz}$		1.5		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 10 \text{ mA}$		1.0		ns
		$I_{rr} = 1 \text{ mA}$ , $R_L = 100 \Omega$				
Detection efficiency	η	$V_{in} = 3 V_{(peak)}$ , $f = 30 MHz$		65		%
		$R_L = 3.9 \text{ k}\Omega, C_L = 10 \text{ pF}$				

Note) 1. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

2. Rated input/output frequency: 2 GHz

3. \*: t<sub>rr</sub> measuring instrument

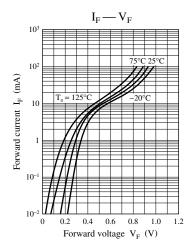


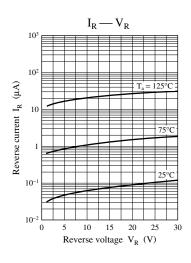


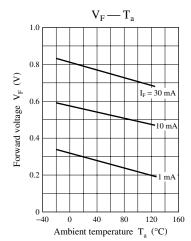
Note) The part number in the parenthesis shows conventional part number.

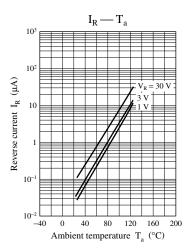
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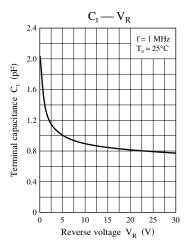
MA6X718 Panasonic











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